

**AMENDMENTS TO THE SPECIFICATION**

**Page 12, after the eighth full paragraph (directly above the header “Description of Symbols”), please insert the following paragraph:**

Fig. 37 is a cross-section showing a part of a manufacturing processes of a multilayered printed circuit board of the present invention.

**Page 13, after the sixteenth full paragraph (directly above the header “Detailed Description of the Invention”), please insert the following two paragraphs:**

100            IC chip

170            solder

PRELIMINARY AMENDMENT AND ELECTION  
Appln. No. 10/049,270

**AMENDMENTS TO THE DRAWINGS**

**Please add the drawing on the attached sheet (Figure 37).**

Attachment: New Drawing Sheet